

F2P322530NVQ1 TYPE

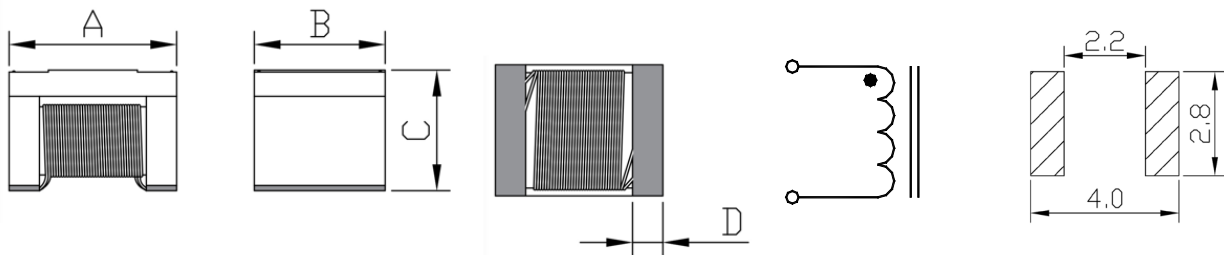
●FEATURE

1. Ensuring consistent high quality and reliability as the result of a completely automated manufacturing process
2. Operating temperature range: -55 to +125°C (including self-temperature rise)
3. Same as Coilcraft 1210POC type

●Applications

1. Inductor for use with separate signal and power lines in in-vehicle PoC (Power Over Coax)
2. Compliant with AEC-Q200

●Shape and Dimension and Schematics and Land Patterns(mm)



A= 3.20±0.20 m/m ; B=2.50±0.20 m/m ; C=3.00±0.20 m/m; D=0.58±0.20 m/m

●Specification

PART NO.	Ls(uH)	DCR(Ω)	Isat (mA)					Itemp (mA)		
			25°C	85°C	105°C	125°C	140°C	25°C	85°C	125°C
F2P322530NVQ1-2R2M	2.2uH	0.13	2200	1900	1700	1500	1300	1900	1730	1000
F2P322530NVQ1-6R8M	6.8uH	0.24	1400	1000	930	800	700	1360	1230	800
F2P322530NVQ1-100M	10uH	0.34	1100	850	760	660	560	560	1030	570
F2P322530NVQ1-220M	22uH	0.88	720	580	520	450	390	390	630	400

Note1. Measurement ambient temperature of electrical : at 25°C

Note2. Test equipment: HP4294A, 100KHz, 0.25V

Note3. Isat: when based on the inductance change rate (30% below the nominal inductance value)

Note4. Itemp. 25°C: When based on the temperature increase (temperature increase of 40°C by self heating)

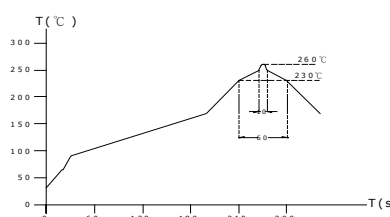
Note5. Itemp.105°C: When based on the temperature increase (temperature increase of 40°C by self heating)

Note6. Itemp.125°C: When based on the temperature increase (temperature increase of 15°C by self heating)

GENERAL CHARACTERISTICS

1. Operating temperature range: -55 TO + 125°C (Includes temperature when the coil is heated)
2. High temperature exposure(storage) refer MIL-STD-202 Method 108: 1000 hrs at rated operating temperature(e.g. 125°C). Part can be stored for 1000 hrs @125°C. Unpowered. Measurement at 24±4 hours after test conclusion.
3. Temperature cycling refer JESD22 Method JA-104: 1000 cycles(-55 TO + 125°C). Measurement at 24±4 hours after test conclusion. 30 min maximum dwell time at each temp. extreme. 1 min. maximum transition time.
4. Biased Humidity refer MIL-STD-202 Method 103: 1000 hours 85°C/85%RH. Unpowered. Measurement at 24±4 hours after test conclusion.
5. Operational Life refer MIL-PRF-27: 1000 hrs. at 125 °C tested. Measurement at 24±4 hours after test conclusion.
6. External Visual refer MIL-STD-883 Method 2009: Inspect device construction, marking and workmanship.
7. Physical Dimension refer JESD22 Method JB-100: Verify physical dimensions to the applicable device detail specification.
8. Resistance to Solvents refer MIL-STD-202 Method 215: Add aqueous wash chemical - OKEM clean or equivalent.
9. Mechanical Shock refer MIL-STD-202 Method 213: Figure 1 of Method 213. Condition C.
10. Vibration refer MIL-STD-202 Method 204: 5g;s for 20 minutes, 12 cycles each of 3 orientations. Test from 10-2000 Hz.
11. Resistance to soldering Heat refer MIL-STD-202 Method 210: Condition B No pre-heat of samples. Single wave solder-procedure 2 for SMD and procedure 1 for leaded with solder within 1.5mm of device body.
12. ESD refer AEC-Q200-002 or ISO/DIS 10605: Direct contact discharge 2kV.
13. Solderability refer J-STD-002: For both Leaded & SMD. Magnification 50X. Conditions: Leaded, Method A@235°C, category 3 ; SMD, a)Method B, 4hrs@125°C dry heat @235°C, b)Method B@215°C category 3., c)Method D category 3@260°C
14. Electrical Characterization refer spec: Show Min, Max Mean and Standard deviation at room from Min and Max temperature.
15. Flammability refer UL-94: V-0 or V-1 Acceptable.
16. Board Flex refer AEC-Q200-005: 60 sec minimum holding time.
17. Terminal Strength(SMD) refer AEC-Q200-006
18. Reflow profile recommend:

Lead-free heat endurance test



Lead-free the recommended reflow condition

